

Fast IGBT in NPT-technology

- 75% lower *E*_{off} compared to previous generation combined with low conduction losses
- \bullet Short circuit withstand time 10 μs
- Designed for:
 - Motor controls
 - Inverter
- NPT-Technology for 600V applications offers:
 - very tight parameter distribution
 - high ruggedness, temperature stable behaviour
 - parallel switching capability
- Qualified according to JEDEC¹ for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <u>http://www.infineon.com/igbt/</u>

Туре	V _{CE}	I _c	V _{CE(sat)}	Tj	Marking	Package
SGP10N60A	600V	10A	2.3V	150°C	G10N60A	PG-TO-220-3-1
SGW10N60A	600V	10A	2.3V	150°C	G10N60A	PG-TO-247-3

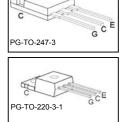
Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V _{CE}	600	V
DC collector current	I _C		А
$T_{\rm C} = 25^{\circ}{\rm C}$		20	
$T_{\rm C}$ = 100°C		10.6	
Pulsed collector current, t_p limited by T_{jmax}	I _{Cpuls}	40	
Turn off safe operating area	-	40	
$V_{CE} \leq 600V, \ T_j \leq 150^\circ C$			
Gate-emitter voltage	V _{GE}	±20	V
Avalanche energy, single pulse	E _{AS}	70	mJ
$I_{\rm C}$ = 10 A, $V_{\rm CC}$ = 50 V, $R_{\rm GE}$ = 25 Ω ,			
start at $T_j = 25^{\circ}C$			
Short circuit withstand time ²	t _{sc}	10	μS
V_{GE} = 15V, $V_{\text{CC}} \le 600$ V, $T_j \le 150^\circ$ C			
Power dissipation	P _{tot}	92	W
$T_{\rm C} = 25^{\circ}{\rm C}$			
Operating junction and storage temperature	$T_{\rm j}$, $T_{ m stg}$	-55+150	°C
Soldering temperature,	T _s	260	
wavesoldering, 1.6mm (0.063 in.) from case for 10s			

¹ J-STD-020 and JESD-022

² Allowed number of short circuits: <1000; time between short circuits: >1s.







Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic	·			•
IGBT thermal resistance,	R _{thJC}		1.35	K/W
junction – case				
Thermal resistance,	R _{thJA}	PG-TO-220-3-1	62	
junction – ambient		PG-TO-247-3-21	40	

Electrical Characteristic, at T_j = 25 °C, unless otherwise specified

Parameter	Symphol	Conditions	Value			Unit
Parameter	Symbol	Conditions	min.	Тур.	max.	Unit
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{\rm GE}$ =0V, $I_{\rm C}$ =500 μ A	600	-	-	V
Collector-emitter saturation voltage	V _{CE(sat)}	$V_{\rm GE}$ = 15V, $I_{\rm C}$ =10A				
		<i>T</i> _j =25°C	1.7	2	2.4	
		<i>T</i> _j =150°C	-	2.3	2.8	
Gate-emitter threshold voltage	V _{GE(th)}	$I_{\rm C} = 300 \mu {\rm A}, V_{\rm CE} = V_{\rm GE}$	3	4	5	
Zero gate voltage collector current	I _{CES}	V_{CE} =600V, V_{GE} =0V				μA
		<i>T</i> _j =25°C	-	-	40	
		<i>T</i> _j =150°C	-	-	1500	
Gate-emitter leakage current	I _{GES}	$V_{\rm CE} = 0 V, V_{\rm GE} = 20 V$	-	-	100	nA
Transconductance	$g_{\rm fs}$	V _{CE} =20V, <i>I</i> _C =10A	-	6.7	-	S
Dynamic Characteristic						
Input capacitance	Ciss	V _{CE} =25V,	-	550	660	pF
Output capacitance	Coss	V _{GE} =0V,	-	62	75	
Reverse transfer capacitance	Crss	f=1MHz	-	42	51	
Gate charge	Q _{Gate}	V _{CC} =480V, <i>I</i> _C =10A	-	52	68	nC
		V _{GE} =15V				
Internal emitter inductance	LE	PG-TO-220-3-1	-	7	-	nH
measured 5mm (0.197 in.) from case		PG-TO-247-3-21	-	13	-	
Short circuit collector current ²⁾	I _{C(SC)}	V_{GE} =15V, t_{SC} ≤10 μ s V_{CC} ≤ 600V, T_j ≤ 150°C	-	100	-	A

 $^{^{2)}}$ Allowed number of short circuits: <1000; time between short circuits: >1s.



Switching Characteristic, Inductive Load, at T_i =25 °C

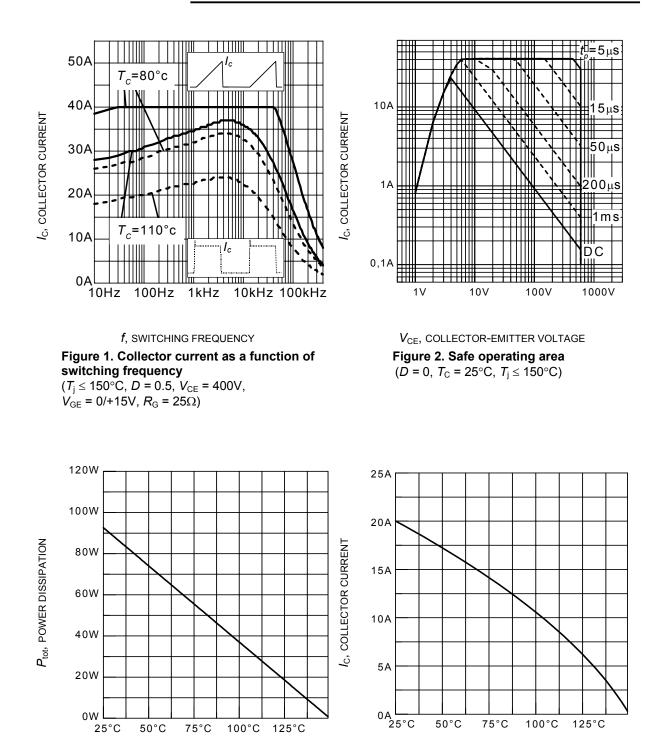
Parameter	Sympol	Conditions	Value			Unit
Parameter	Symbol Conditions		min.	typ.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t _{d(on)}	<i>T</i> _j =25°C,	-	28	34	ns
Rise time	t _r	$V_{\rm CC} = 400 V, I_{\rm C} = 10 A,$	-	12	15	
Turn-off delay time	$t_{d(off)}$	V _{GE} =0/15V, R _G =25Ω,	-	178	214	
Fall time	t _f	$L_{\sigma}^{(1)} = 180 \text{ nH},$	-	24	29	
Turn-on energy	Eon	$C_{\sigma}^{(1)} = 55 \text{pF}$	-	0.15	0.173	mJ
Turn-off energy	E _{off}	Energy losses include "tail" and diode	-	0.17	0.221	
Total switching energy	E _{ts}	reverse recovery.	-	0.320	0.394]

Switching Characteristic, Inductive Load, at T_j =150 °C

Parameter	Symbol	Conditions	Value			Unit
Parameter	Symbol Conditions		min.	typ.	max.	Unit
IGBT Characteristic	·					
Turn-on delay time	t _{d(on)}	<i>T</i> _j =150°C	-	28	34	ns
Rise time	t _r	V _{CC} =400V, <i>I</i> _C =10A, V _{GE} =0/15V,	-	12	15	
Turn-off delay time	$t_{d(off)}$	$R_{\rm G}=25\Omega$	-	198	238	
Fall time	t _f	$L_{\sigma}^{(1)} = 180 \text{ nH},$	-	26	32	
Turn-on energy	Eon	$C_{\sigma}^{1)}$ =55pF	-	0.260	0.299	mJ
Turn-off energy	E _{off}	Energy losses include "tail" and diode	-	0.280	0.364	
Total switching energy	Ets	reverse recovery.	-	0.540	0.663	1

 $^{1)}$ Leakage inductance L $_{\sigma}$ and $\,$ Stray capacity C $_{\sigma}$ due to dynamic test circuit in Figure E.





 $T_{\rm C}$, CASE TEMPERATURE Figure 3. Power dissipation as a function of case temperature $(T_{i} \le 150^{\circ}C)$

75°C

100°C

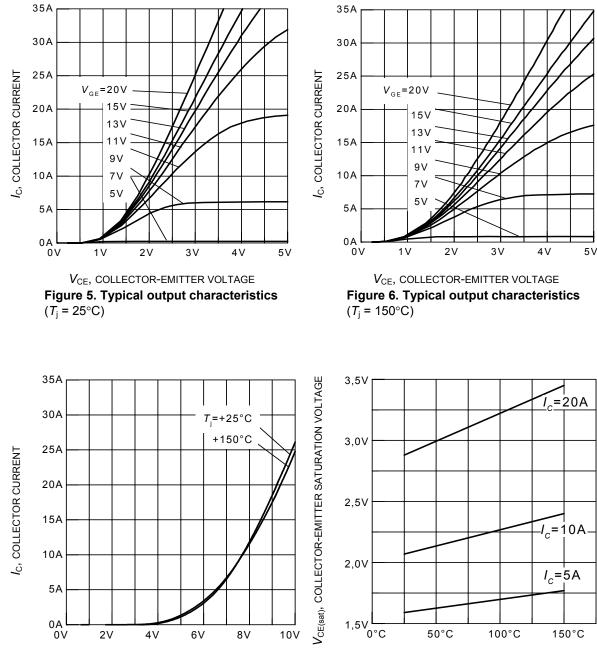
125°C

25°C

50°C

 $T_{\rm C}$, CASE TEMPERATURE Figure 4. Collector current as a function of case temperature $(V_{\rm GE} \le 15 {\rm V}, T_{\rm i} \le 150^{\circ}{\rm C})$

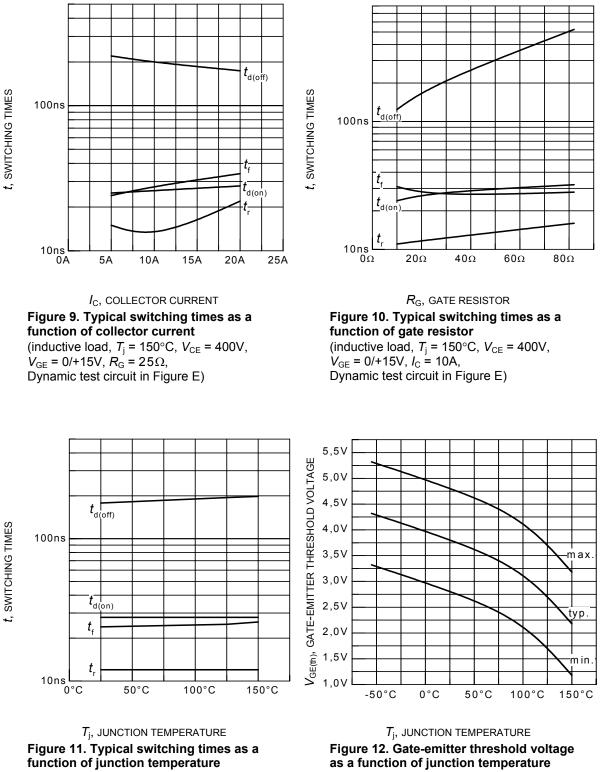






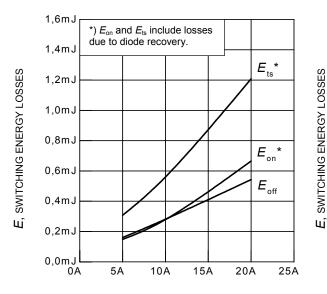




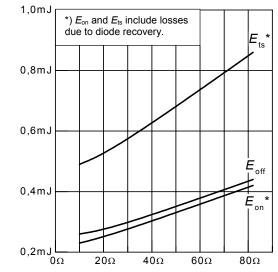




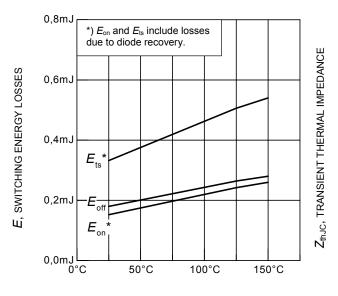


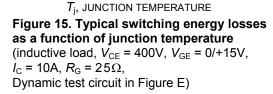


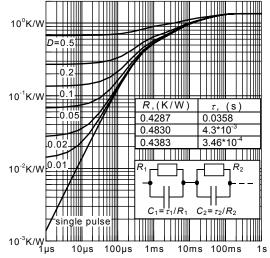
 $I_{\rm C}$, COLLECTOR CURRENT **Figure 13. Typical switching energy losses as a function of collector current** (inductive load, $T_{\rm j}$ = 150°C, $V_{\rm CE}$ = 400V, $V_{\rm GE}$ = 0/+15V, $R_{\rm G}$ = 25 Ω , Dynamic test circuit in Figure E)



 $R_{\rm G}$, GATE RESISTOR Figure 14. Typical switching energy losses as a function of gate resistor (inductive load, $T_{\rm j}$ = 150°C, $V_{\rm CE}$ = 400V, $V_{\rm GE}$ = 0/+15V, $I_{\rm C}$ = 10A, Dynamic test circuit in Figure E)



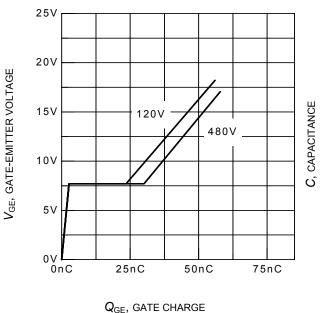


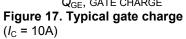


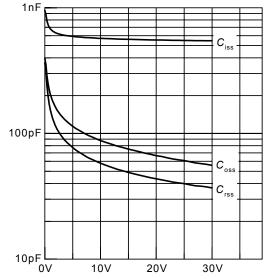
$t_{\rm p}$, PULSE WIDTH



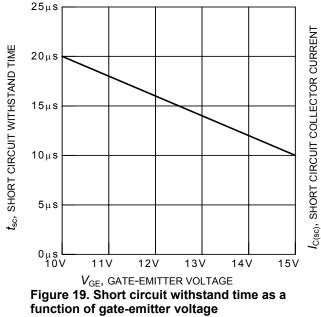








 V_{CE} , COLLECTOR-EMITTER VOLTAGE Figure 18. Typical capacitance as a function of collector-emitter voltage (V_{GE} = 0V, f = 1MHz)



 $(V_{CE} = 600V, \text{ start at } T_{i} = 25^{\circ}C)$

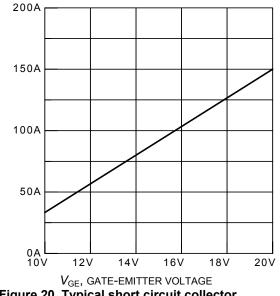
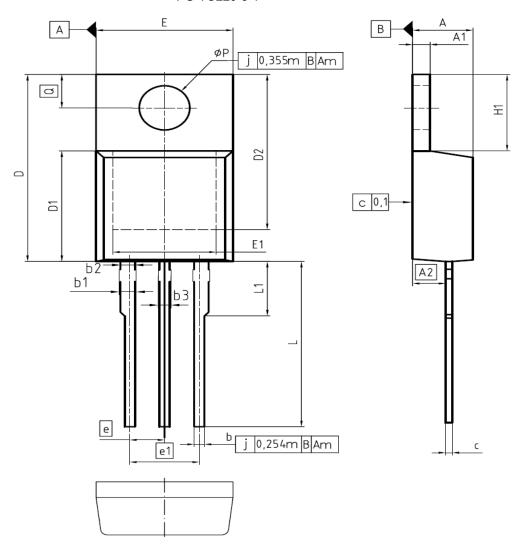


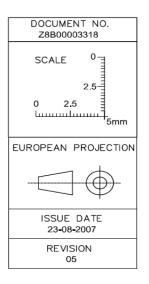
Figure 20. Typical short circuit collector current as a function of gate-emitter voltage ($V_{CE} \le 600V$, $T_j = 150^{\circ}C$)



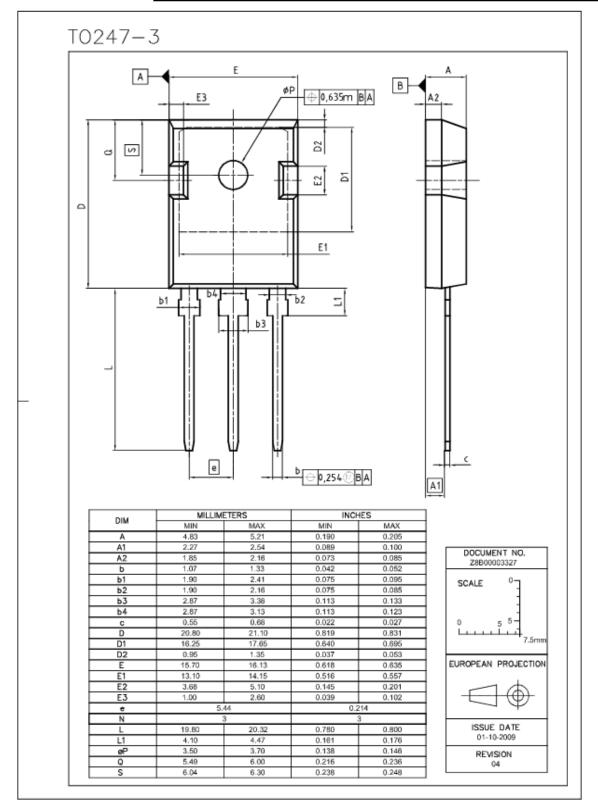




DIM	MILLIM	ETERS	INCH	IES	
DIM	MIN	MAX	MIN	MAX	
A	4.30	4,57	0.169	0.180	
A1	1.17	1.40	0.046	0.055	
A2	2,15	2,72	0.085	0.107	
b	0.65	0.86	0.026	0.034	
Ь1	0.95	1.40	0.037	0.055	
b2	0.95	1.15	0.037	0.045	
b3	0.65	1,15	0.026	0.045	
с	0.33	0.60	0.013	0.024	
D	14.81	15.95	0.583	0.628	
D1	8.51	9.45	0.335	0.372	
D2	12.19	13.10	0.480	0.516	
E	9.70	10.36	0.382	0.408	
E1	6.50	8.60	0,256	0.339	
е	2.5	54	0.100		
e1	5.0)8	0.2	00	
N		3	:	3	
H1	5.90	6.90	0.232	0.272	
L	13.00	14.00	0.512	0.551	
L1	-	4.80	-	0.189	
øP	3.60	3.89	0.142	0.153	
Q	2.60	3.00	0.102	0.118	









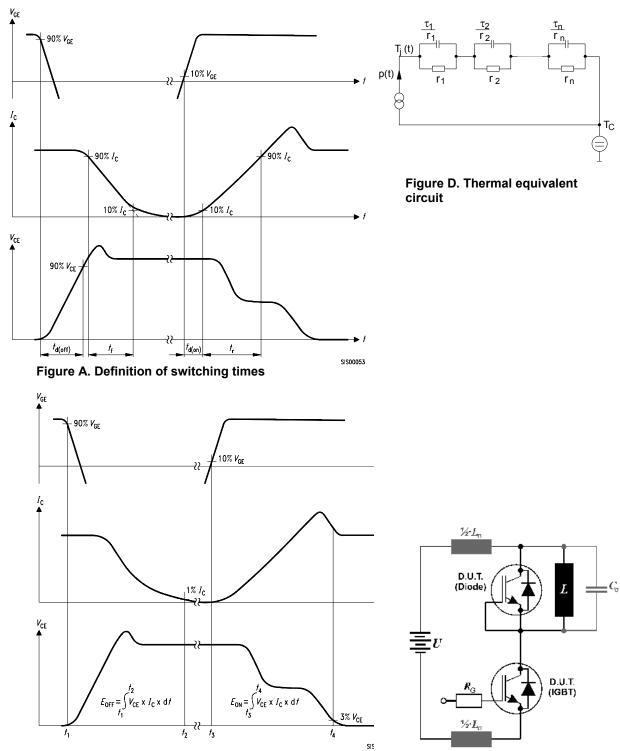
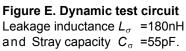


Figure B. Definition of switching losses





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